

**AMENDMENTS TO THE SPECIFICATION**

Pages 8-9, Brief Description of the Drawings:

FIG. 1 is a schematic cross-sectional drawing of a conventional interconnect structure;

FIG. 2 is a schematic cross-sectional drawing of a conventional interconnect structure;

FIG. 3 is a schematic cross-sectional drawing of a conventional interconnect structure;

FIG. 4 is a schematic cross-sectional drawing of an interconnect structure according to the present invention;

~~FIG. 5 includes~~FIGS. 5A to 5C include schematic cross-sectional drawings showing a manufacturing method of the interconnect according to the invention;

~~FIG. 6 includes~~FIGS. 6A and 6B include schematic cross-sectional drawings of an interconnect structure according to the invention;

FIG. 7 is a schematic cross-sectional drawing of an interconnect structure according to the invention;

~~FIG. 8 includes~~FIGS. 8A to 8C include schematic cross-sectional drawings showing a manufacturing method of the interconnect according to the invention;

FIG. 9 is a schematic cross-sectional drawing of an interconnect structure according to the invention;

~~FIG. 10 includes~~FIGS. 10A to 10C include schematic cross-sectional drawings showing a manufacturing method of the interconnect according to the invention;

~~FIG. 11 includes~~FIGS. 11A to 11C include schematic cross-sectional drawings for explaining an evaluating method of interlayer adhesion;

Sadayuki OHNISHI  
Q76993  
Preliminary Amendment

FIG. 12 is a bar graph showing an evaluation result of interlayer adhesion; and

FIG. 13 is a schematic cross-sectional drawing of a multilayer interconnect structure.